

# SKM 600GA125D



**SEMITRANS™ 4**

## Ultra Fast IGBT Modules

### SKM 600GA125D

#### Preliminary Data

#### Features

- NPT-IGBT with positive temperature coefficient of  $V_{CE(sat)}$
- Short circuit self limiting to  $6 \times I_c$
- Corresponds to standards: IEC 60721-3-3 (humidity) class 3K3/IEC 68T.1 climate 40/125/56

#### Typical Applications

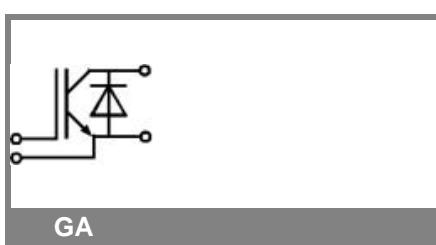
- Resonant inverters upto 100 kHz
- Inductive heating
- Electronic welders at  $f_{SW} > 20$  kHz

#### Remarks

- $I_{DC} \leq 500$ A limited by terminals
- Take care of over-voltage caused by stray inductances.

Absolute Maximum Ratings		$T_c = 25$ °C, unless otherwise specified		
Symbol	Conditions	Values		Units
<b>IGBT</b>				
$V_{CES}$		1200		V
$I_c$	$T_c = 25$ (80) °C	580 (400)		A
$I_{CRM}$	$t_p = 1$ ms	800		A
$V_{GES}$		$\pm 20$		V
$T_{vj}$ ( $T_{stg}$ )	$T_{OPERATION} \leq T_{stg}$	- 40 ... + 150 (125)		°C
$V_{isol}$	AC, 1 min.	4000		V
<b>Inverse diode</b>				
$I_F$	$T_c = 25$ (80) °C	500 (350)		A
$I_{FRM}$	$t_p = 1$ ms	800		A
$I_{FSM}$	$t_p = 10$ ms; sin.; $T_j = 150$ °C	3600		A

Characteristics		$T_c = 25$ °C, unless otherwise specified		
Symbol	Conditions	min.	typ.	max.
<b>IGBT</b>				
$V_{GE(th)}$	$V_{GE} = V_{CE}$ , $I_c = 16$ mA	4,5	5,5	6,5
$I_{CES}$	$V_{GE} = 0$ , $V_{CE} = V_{CES}$ , $T_j = 25$ (125) °C	0,15	0,45	mA
$V_{CE(TO)}$	$T_j = 25$ (125) °C	1,5 (1,7)	1,75	V
$r_{CE}$	$V_{GE} = 15$ V, $T_j = 25$ (125) °C	4,5 (6)	5,3	mΩ
$V_{CE(sat)}$	$I_{Cnom} = 400$ A, $V_{GE} = 15$ V, chip level	3,3 (4)	3,85	V
$C_{ies}$	under following conditions	36		nF
$C_{oes}$	$V_{GE} = 0$ , $V_{CE} = 25$ V, $f = 1$ MHz	3,8		nF
$C_{res}$		3,5		nF
$L_{CE}$		20		nH
$R_{CC' + EE'}$	res., terminal-chip $T_c = 25$ (125) °C	0,18 (0,22)		mΩ
$t_{d(on)}$	$V_{CC} = 600$ V, $I_{Cnom} = 400$ A	80		ns
$t_r$	$R_{Gon} = R_{Goff} = 2,5$ Ω, $T_j = 125$ °C	70		ns
$t_{d(off)}$	$V_{GE} = \pm 15$ V	570		ns
$t_f$		60		ns
$E_{on}$ ( $E_{off}$ )		30 (22)		mJ
<b>Inverse diode</b>				
$V_F = V_{EC}$	$I_{Cnom} = 400$ A; $V_{GE} = 0$ V; $T_j = 25$ (125)	2 (1,8)	2,5	V
$V_{(TO)}$	$T_j = 25$ (125) °C		(1,2)	V
$r_T$	$T_j = 25$ (125) °C		(3)	mΩ
$I_{RRM}$	$I_{Cnom} = 400$ A; $T_j = 125$ ( ) °C	460		A
$Q_{rr}$	$di/dt = 7200$ A/μs	65		μC
$E_{rr}$	$V_{GE} = 0$ V	27		mJ
<b>Thermal characteristics</b>				
$R_{th(j-c)}$	per IGBT		0,041	K/W
$R_{th(j-c)D}$	per Inverse Diode		0,09	K/W
$R_{th(c-s)}$	per module		0,038	K/W
<b>Mechanical data</b>				
$M_s$	to heatsink M6	3	5	Nm
$M_t$	to terminals M6 (M4)	2,5 (1,1)	5 (2)	Nm
w			330	g



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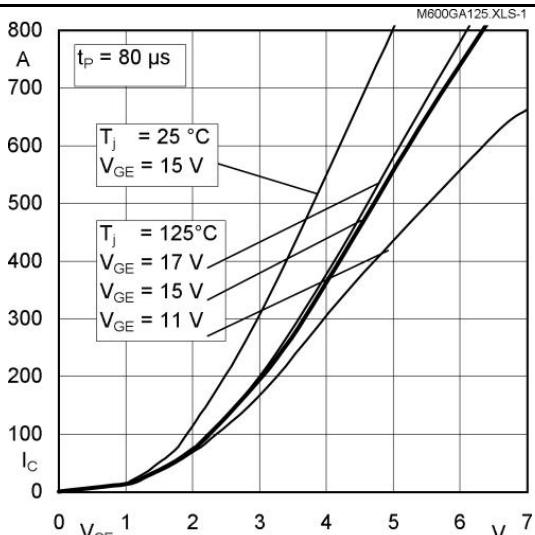


Fig. 1 Typ. output characteristic, inclusive  $R_{CC+EE}$

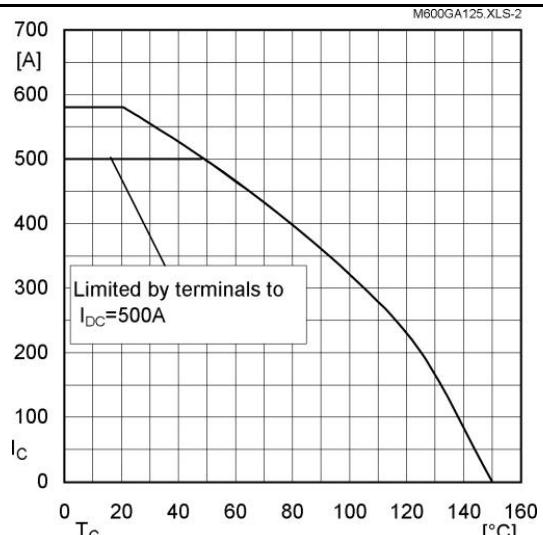


Fig. 2 Rated current vs. temperature  $I_C = f(T_C)$

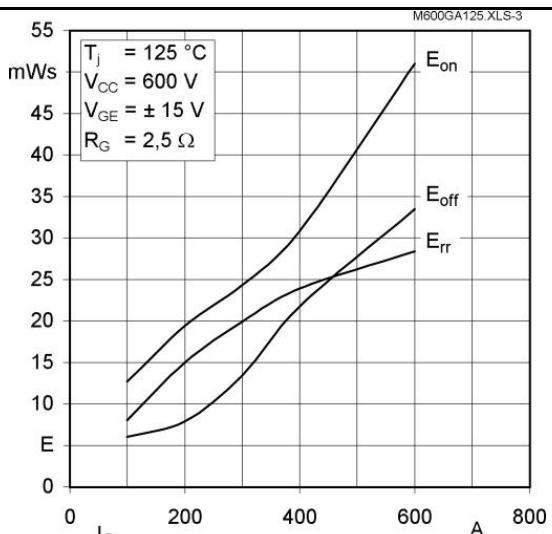


Fig. 3 Typ. turn-on /-off energy =  $f(I_C)$

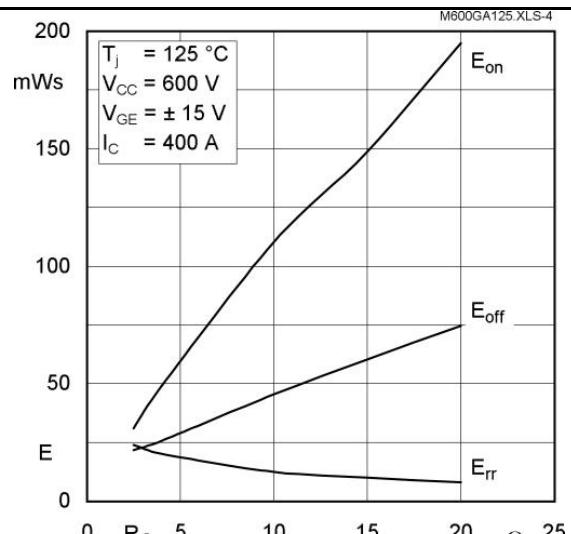


Fig. 4 Typ. turn-on /-off energy =  $f(R_G)$

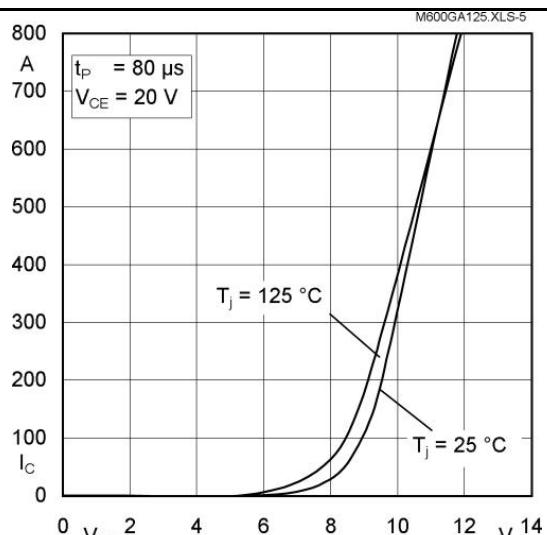


Fig. 5 Typ. transfer characteristic

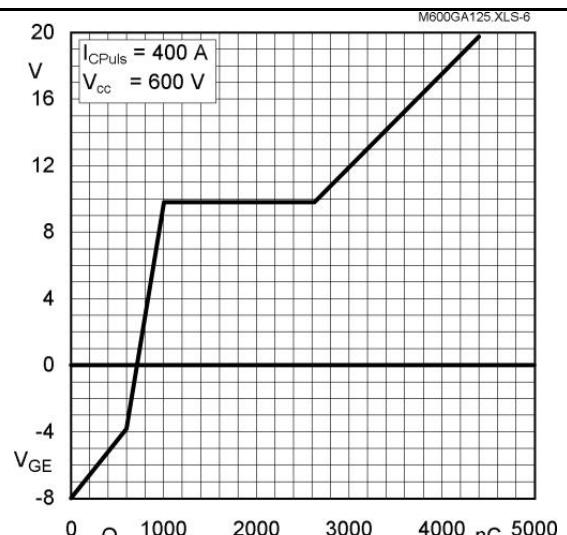


Fig. 6 Typ. gate charge characteristic

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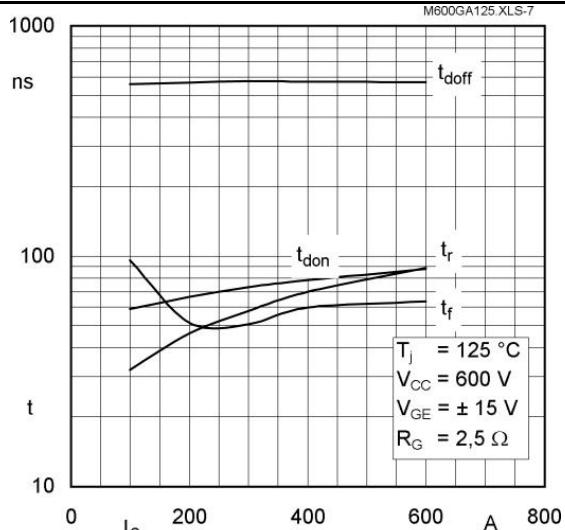


Fig. 7 Typ. switching times vs.  $I_C$

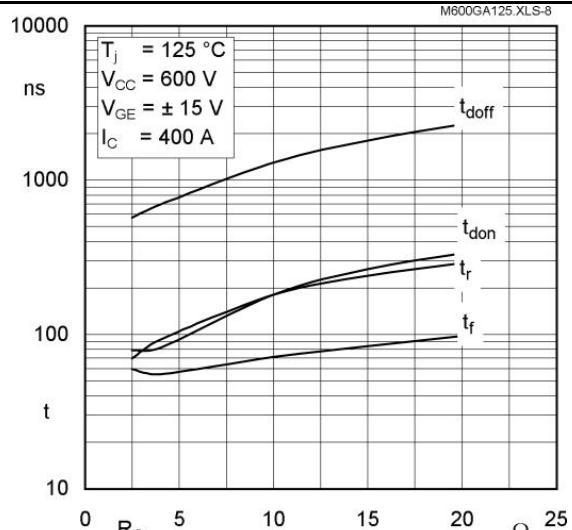


Fig. 8 Typ. switching times vs. gate resistor  $R_G$

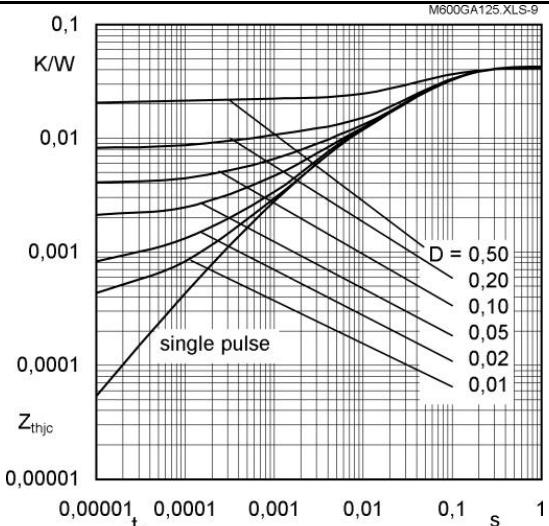


Fig. 9 Transient thermal impedance of IGBT

$$Z_{thp(j-c)} = f(t_p); D = t_p/t_c = t_p * f$$

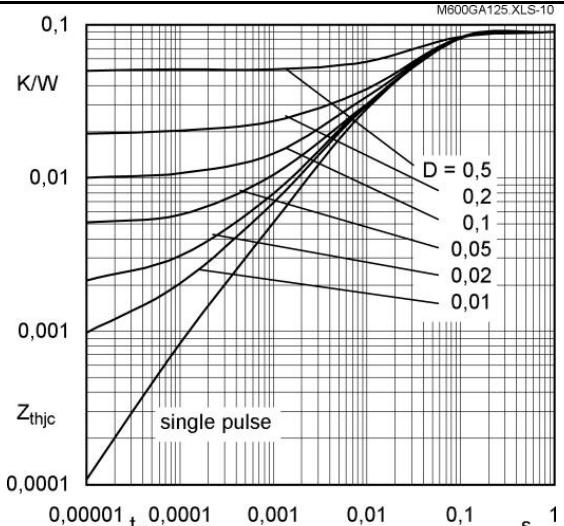


Fig. 10 Transient thermal impedance of Inverse CAL Diode

$$Z_{thp(j-c)} = f(t_p); D = t_p/t_c = t_p * f$$

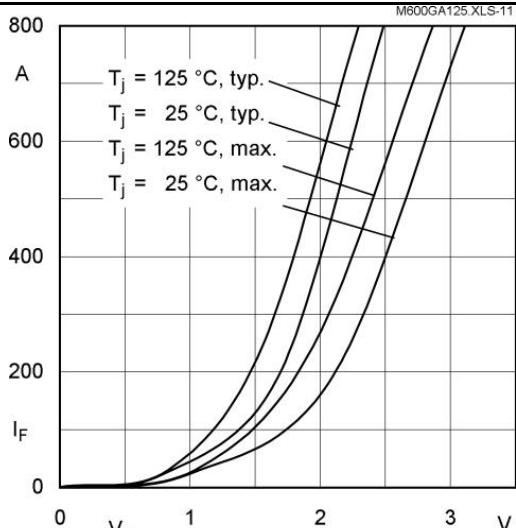


Fig. 11 CAL diode forward characteristic

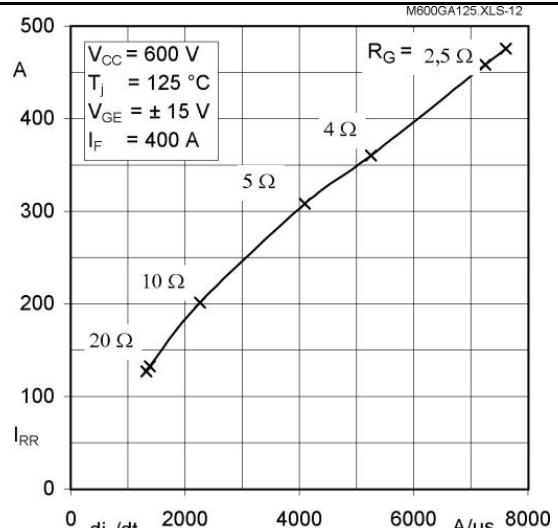
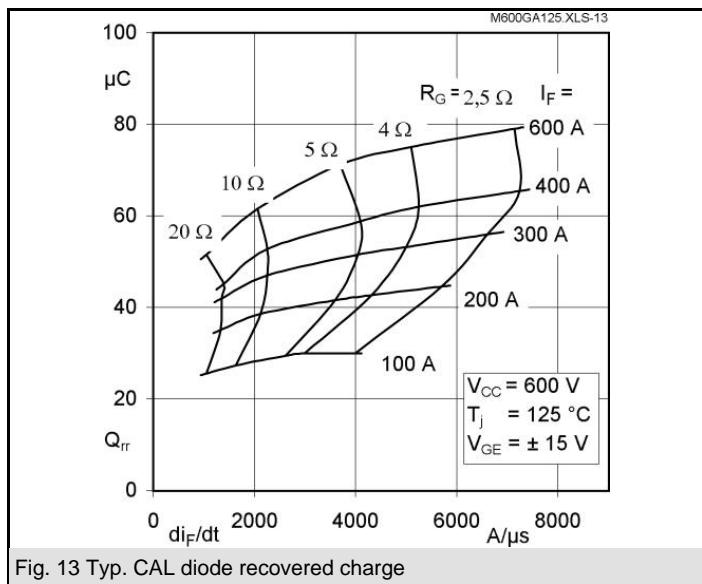


Fig. 12 Typ. CAL diode peak reverse recovery current

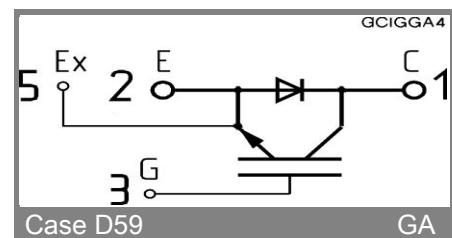
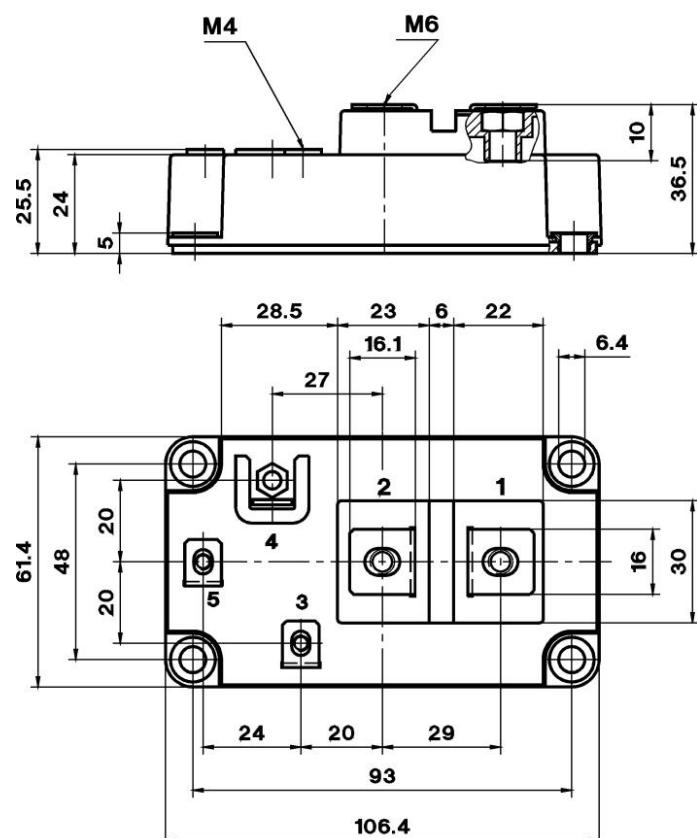
# SKM 600GA125D



UL Recognized  
File no. E 63 532

Dimensions in mm

CASED59



This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

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